



Chapter 17.

MOSFETs - An Introduction

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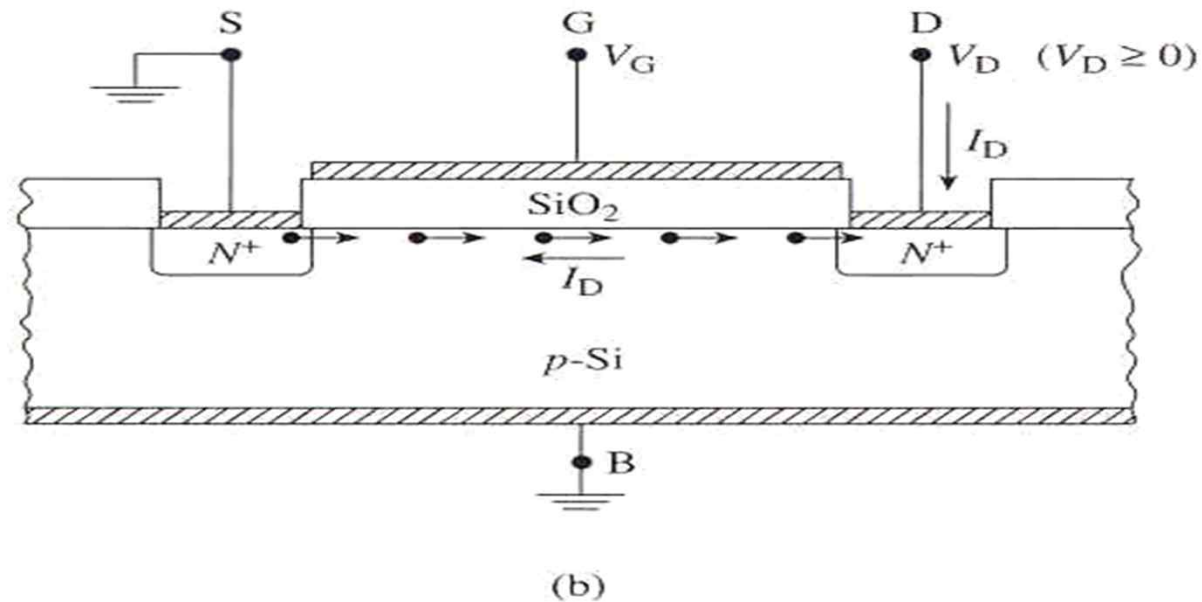
CONTENTS

- **Qualitative Theory of Operation**
- **Quantitative $I_D - V_D$ Relationships**
- **Subthreshold Swing**
- **ac Response**



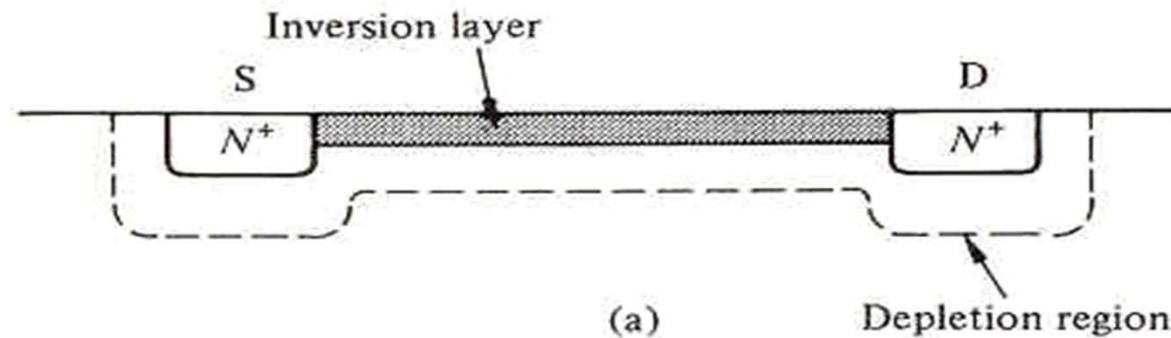
Qualitative Theory of Operation

- **Assumption**
 - Ideal Structure
 - Long Channel Enhancement-Mode
 - MOSFET=MOS-Capacitor + 2 pn junctions
 - n - channel (p-type substrate)

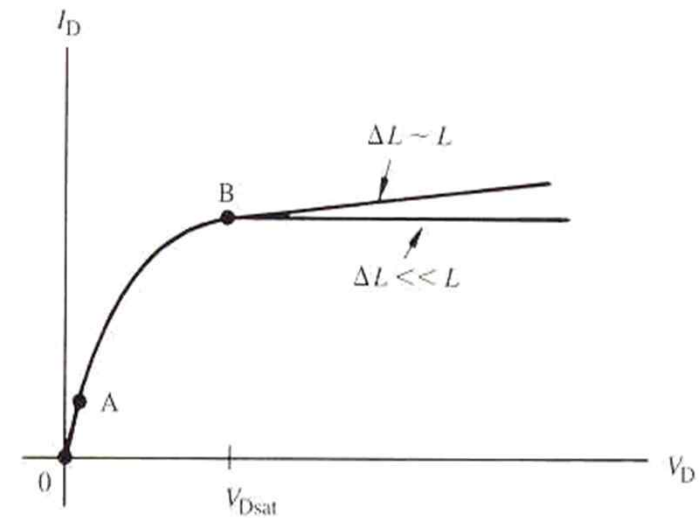
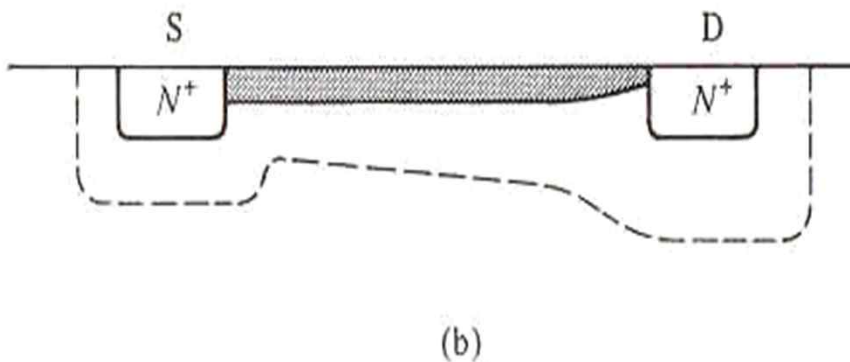


$$V_D = 0 \text{ Case}$$

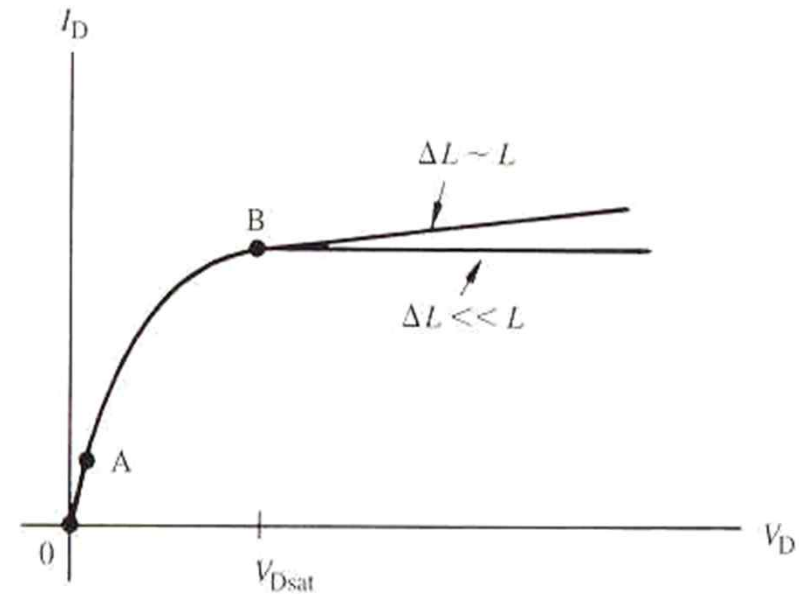
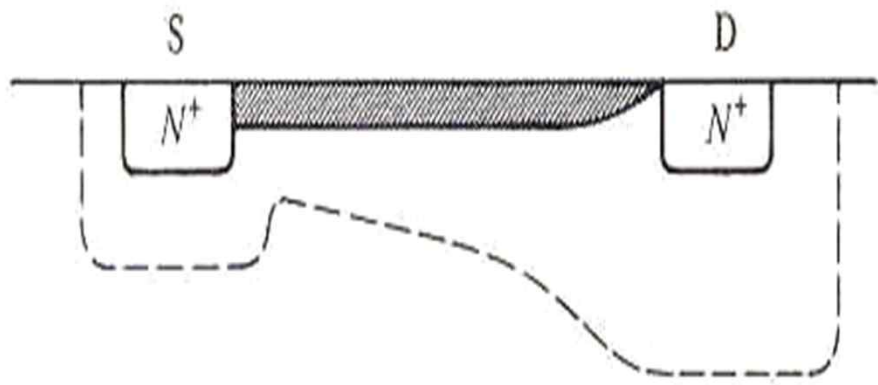
- **When $V_G \leq V_T$, very few electrons in the channel. an open circuit between the n^+ region**
- **When $V_G > V_T$,**
 - Inversion layer is formed
 - The conducting channel (induced “n-type” region, inversion layer) connects the D & S
 - $V_G \uparrow$ the pile up of electrons \uparrow conductance \uparrow
 - $\therefore V_G$ determines the maximum conductance
 - Thermal equilibrium prevails, and $I_D = 0$



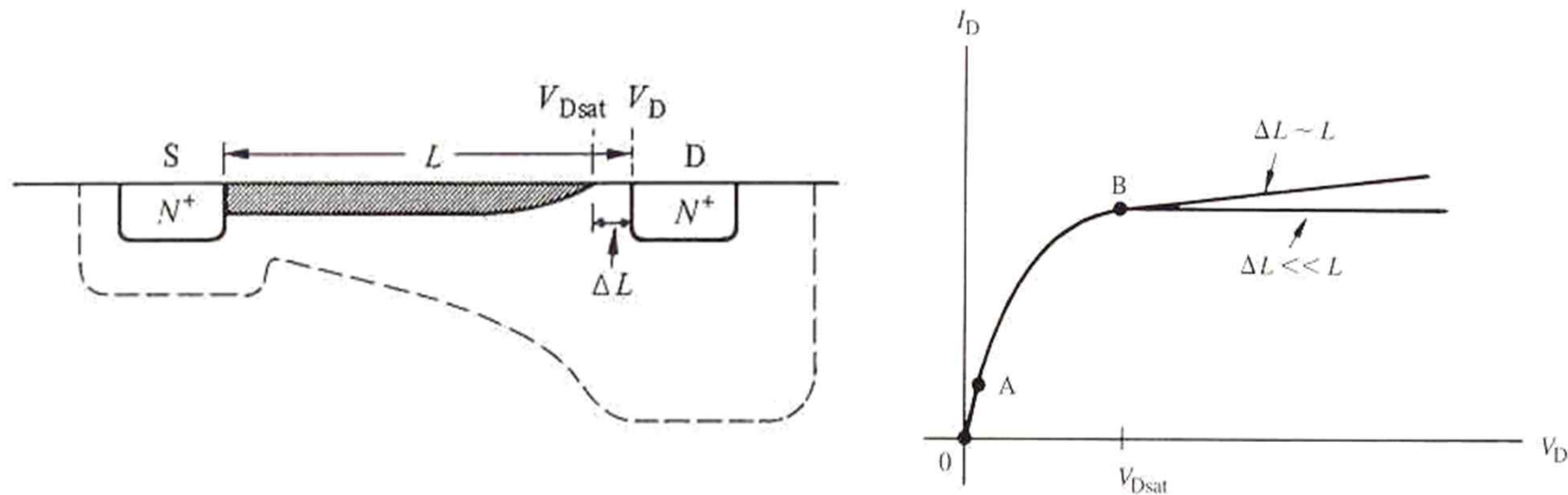
- The V_D is increased in small steps starting from $V_D = 0$
 - The channel acts like a simple resistor
 - $I_D \propto V_D$
 - The reverse bias junction current is negligible
 - voltage drop from the drain to the source starts to negate the inverting effect of the gate
 - $V_D \uparrow$ Depletion of the channel \uparrow # of carriers \downarrow conductance \downarrow slope-over in the IV



- **Pinch - off ($V_D = V_{Dsat}$)**
 - Disappearance of the channel adjacent to the drain
 - The slope of the $I_D - V_D$ becomes approximately zero (Point B)



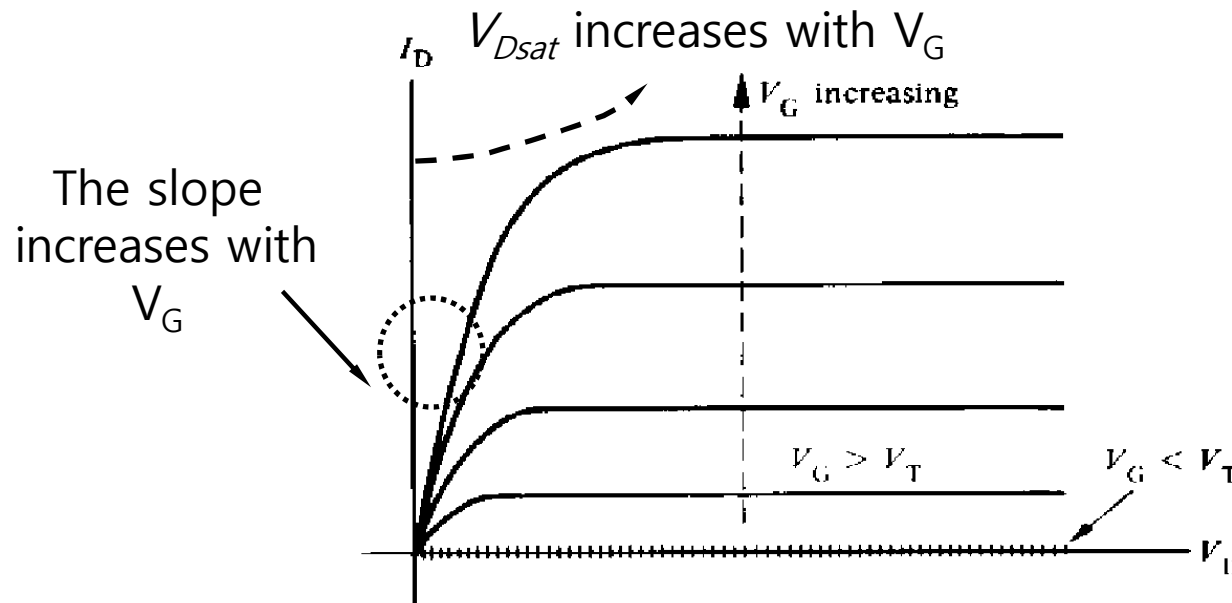
- **Post-pinch-off ($V_D > V_{Dsat}$)**
 - The pinched-off portion widens from just a point into a depleted channel section ΔL
 - The pinched-off section absorbs most of the voltage drop in excess of V_{Dsat}
 - For $\Delta L \ll L$, the shape of the conducting region and the potential across the region do not change Constant I_D
 - For $\Delta L \sim L$, I_D will increase with $V_D > V_{Dsat}$



$I_D - V_D$ Characteristics

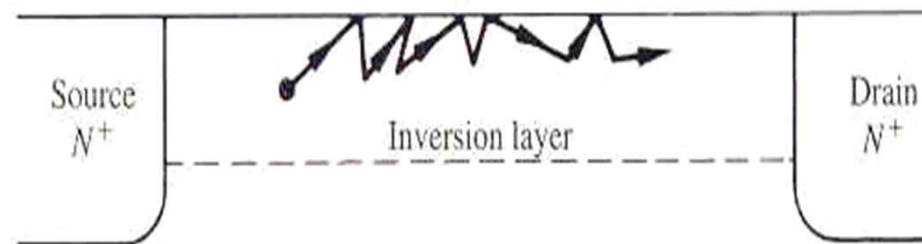
- **General form of the $I_D - V_D$ ($\Delta L \ll L$)**

- For $V_G \leq V_T$, $I_D \approx 0$
- For $V_G > V_T$, transistor action: I_D is modulated by V_G
- $V_D > V_{Dsat}$: saturation region
- $V_D < V_{Dsat}$: linear(triode) region



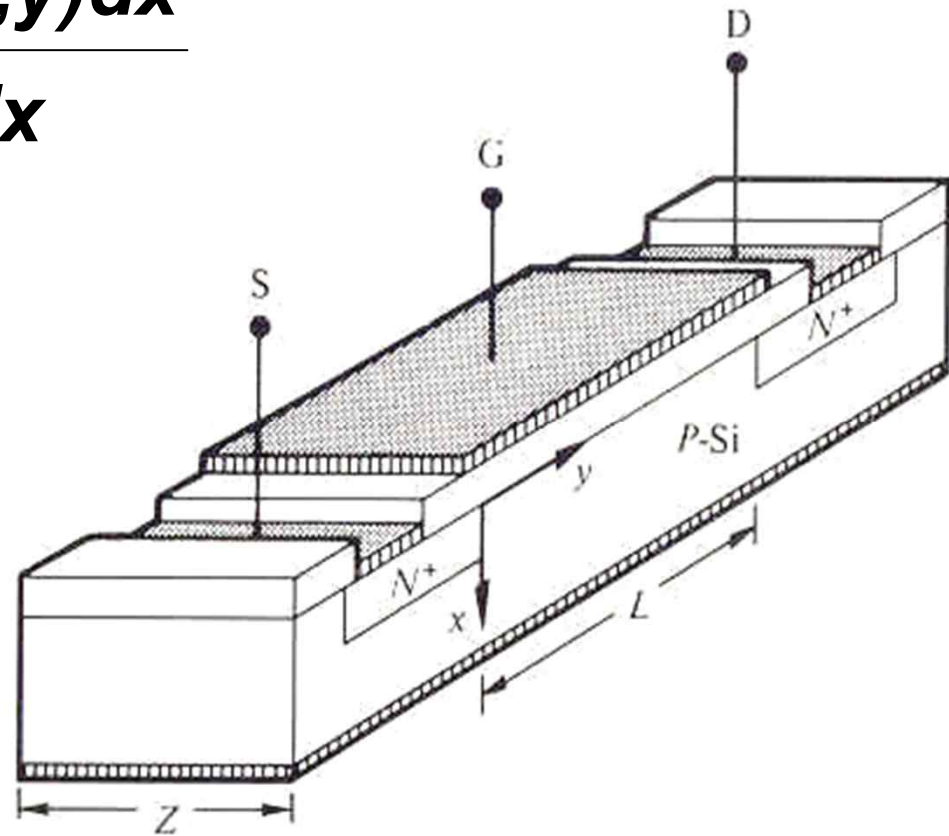
Quantitative $I_D - V_D$ Relationships

- **Effective Mobility**
 - : **Impurity Scattering**
 - + **Lattice Scattering**
 - + **Surface Scattering**

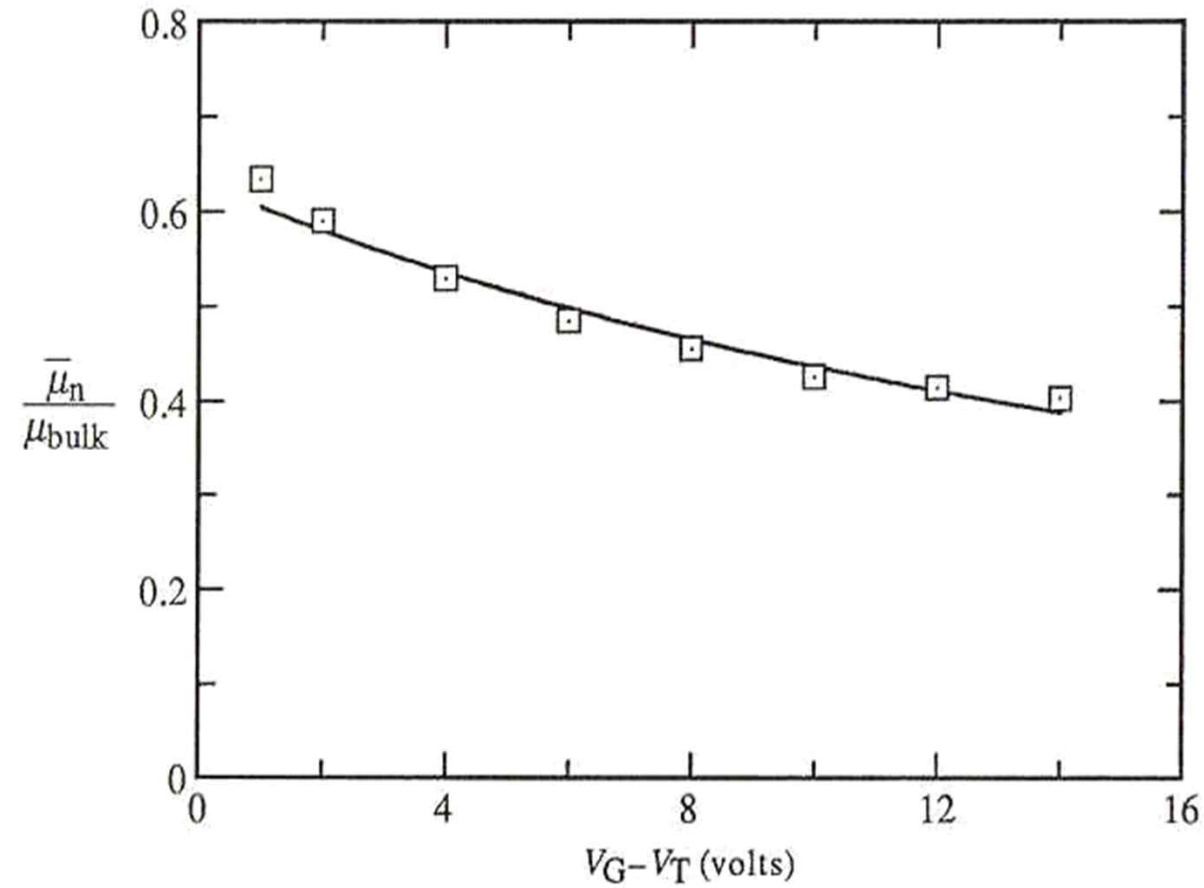


- **Effective Mobility**

$$\bar{\mu}_n = \frac{\int_0^{x_c(y)} \mu_n(x,y) n(x,y) dx}{\int_0^{x_c(y)} n(x,y) dx}$$



$-V_G \uparrow \rightarrow \left\{ \begin{array}{l} \text{more carriers closer to the interface higher} \\ \text{electric field} \end{array} \right\} \rightarrow \text{surface scattering} \uparrow$
 $\rightarrow \bar{\mu}_n \downarrow$



- **Square - Law Theory**

- $V_D < V_{Dsat}$

- A drift current is dominant

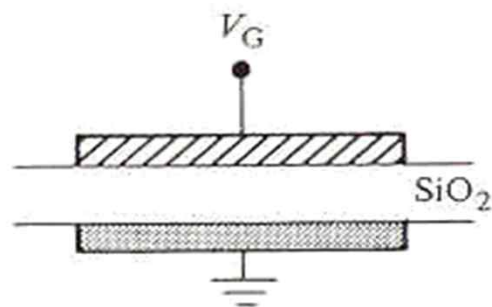
$$Q_{gate} = -Q_{semi} \cong -Q_N$$

$$Q_N \cong -C_o(V_G - V_T)$$

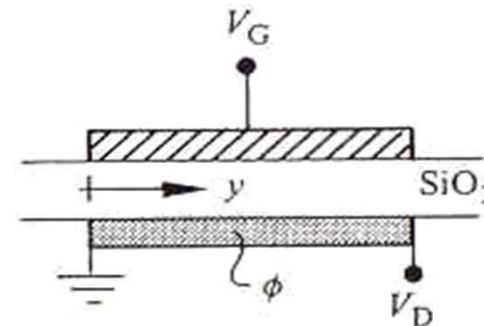
At an arbitrary point y

$$Q_N(y) \cong -C_o(V_G - V_T - \phi) \rightarrow I_D = -WQ_N(y)\bar{\mu}_n E(y)$$

$$= W\bar{\mu}_n C_o(V_G - V_T - \phi) \frac{d\phi}{dy}$$



MOS-C



MOSFET



Integrating

$$\int_0^L I_D dy = W \bar{\mu}_n C_o \int_0^{V_D} (V_G - V_T - \phi) d\phi$$

$$\rightarrow I_D = \frac{W \bar{\mu}_n C_o}{L} \left[(V_G - V_T) V_D - \frac{V_D^2}{2} \right]$$



$$- V_D \geq V_{Dsat}$$

• I_D is approximately constant

$$I_{Dsat} = \frac{W\bar{\mu}_n C_o}{L} \left[(V_G - V_T)V_{Dsat} - \frac{V_{Dsat}^2}{2} \right]$$

$$Q_N(L) = -C_o(V_G - V_T - V_{Dsat}) = 0$$

$$V_{Dsat} = V_G - V_T$$

$$I_{Dsat} = \frac{W\bar{\mu}_n C_o}{2L} (V_G - V_T)^2$$



- **Subthreshold transfer characteristics**

- At weak inversion, diffusion current dominates

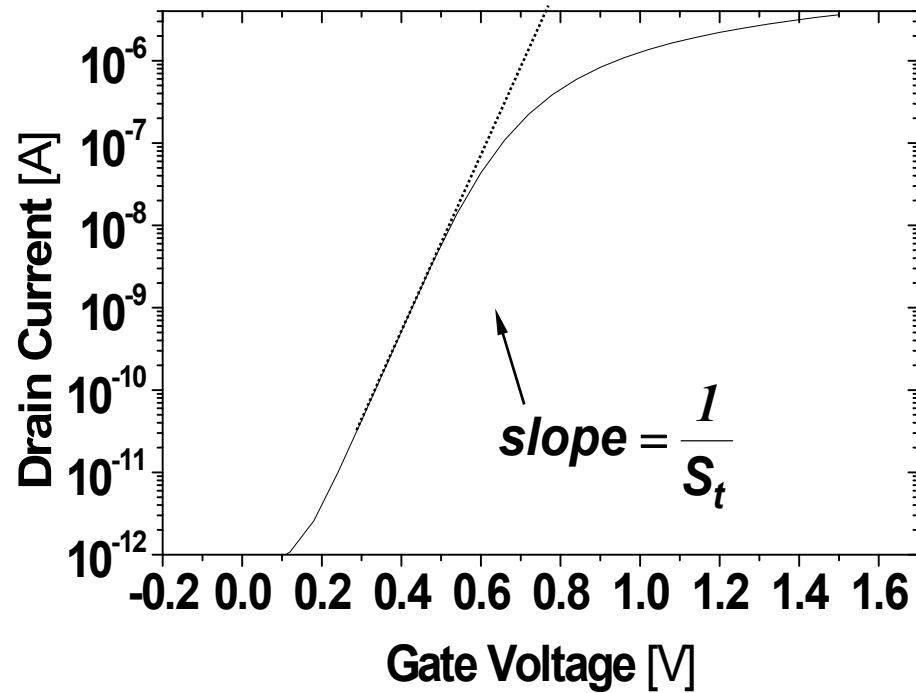
$$I \approx I_{diff} \propto \frac{Q_S - Q_D}{L} \propto \frac{Q_S}{L} \left[1 - \exp\left(-\frac{qV_D}{kT}\right) \right]$$

$$\text{where } Q_D = Q_S \exp\left(-\frac{qV_D}{kT}\right)$$

where Q_S is exponential function of V_G

- In long channel MOSFETS the subthreshold current varies exponentially with V_G and is independent of V_D provided $V_D >$ a few kT/q





Subthreshold swing

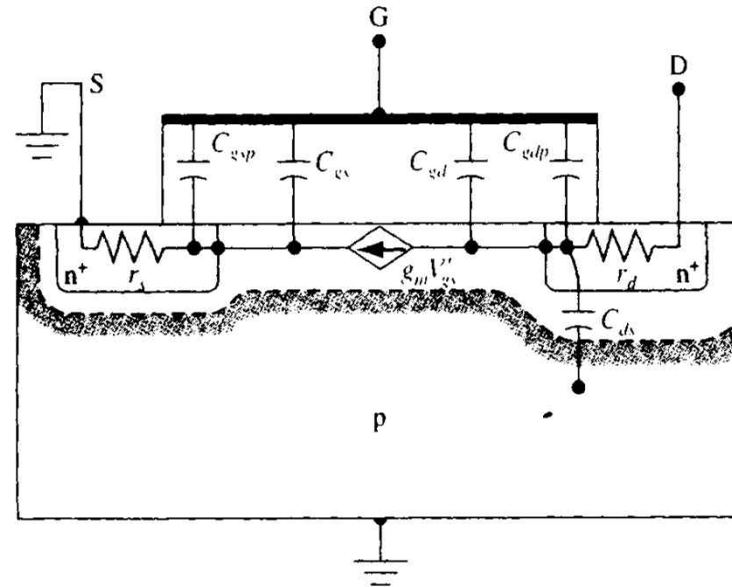
$$S_t = \frac{1}{\frac{d \log I_D}{dV_G}} \text{ [mV/dec]}$$

= change in V_G

for a decade change in I_D



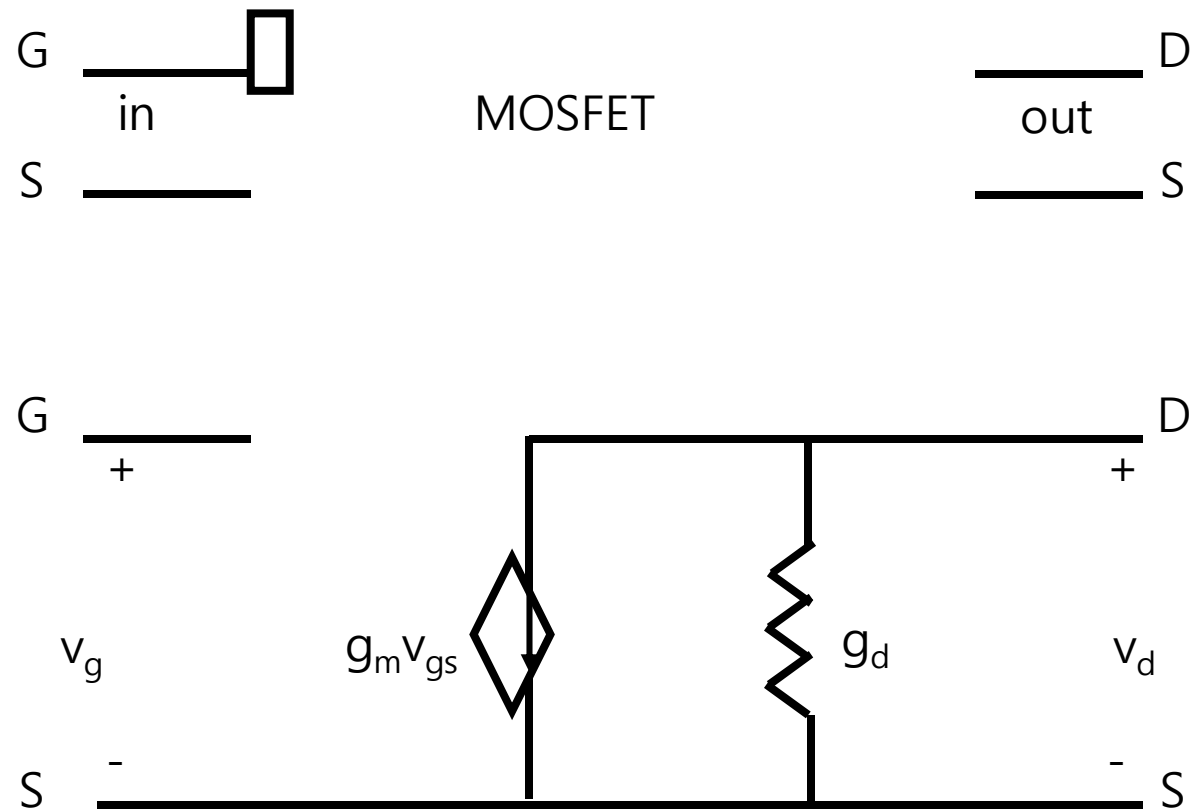
17.3 a.c. Response(skip)

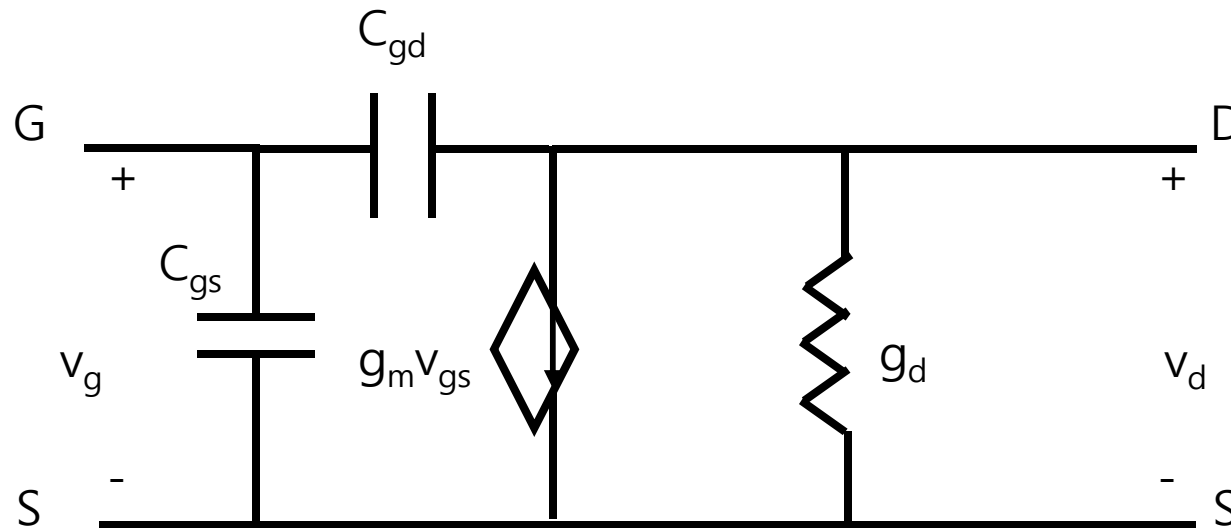


- C_{gs} (C_{gd}): The interaction between G and the channel charge near S(D)
- C_{gsp} , C_{gdp} : parasitic or overlap capacitances



- **Small-signal equivalent circuit**





- A capacitor behaves like an open circuit at low frequencies.

- $I_D(V_D, V_G) + i_d = I_D(V_D + v_d, V_G + v_g)$
- $i_d = I_D(V_D + v_d, V_G + v_g) - I_D(V_D, V_G)$

$$I_D(V_D + v_d, V_G + v_g) = I_D(V_D, V_G) + \left. \frac{\partial I_D}{\partial V_D} \right|_{V_G} v_d + \left. \frac{\partial I_D}{\partial V_G} \right|_{V_D} v_g$$

$$\therefore i_d = \left. \frac{\partial I_D}{\partial V_D} \right|_{V_G} v_d + \left. \frac{\partial I_D}{\partial V_G} \right|_{V_D} v_g$$

$$g_d = \left. \frac{\partial I_D}{\partial V_D} \right|_{V_G = \text{constant}}$$

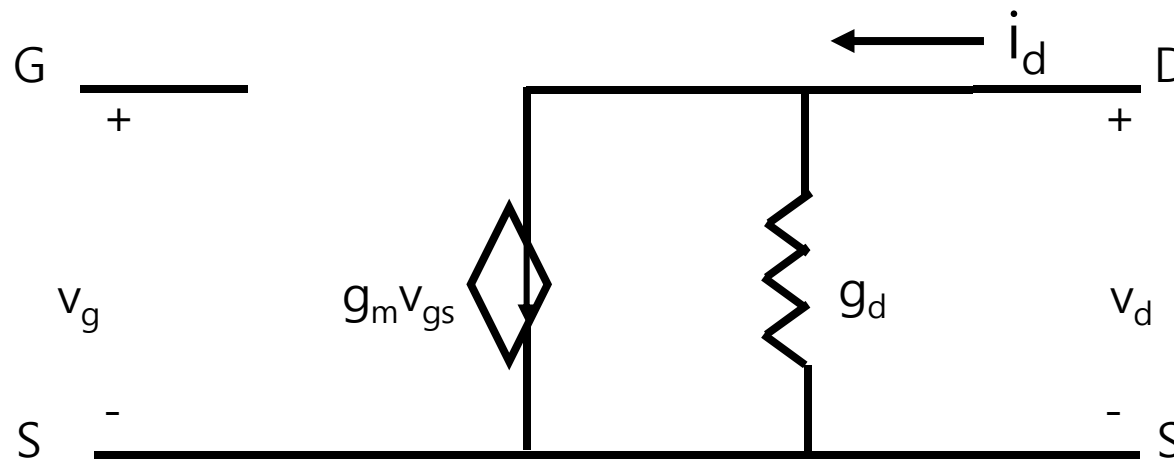
...the drain or channel conductance

$$g_m = \left. \frac{\partial I_D}{\partial V_G} \right|_{V_D = \text{constant}}$$

...transconductance or mutual conductance



$$\therefore i_d = g_d v_d + g_m v_g$$

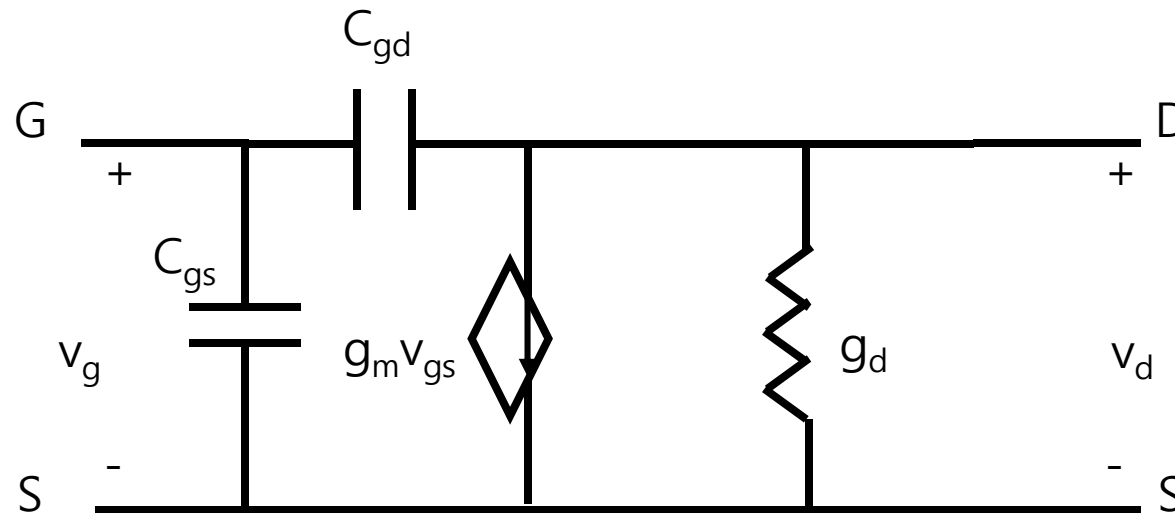


- Table 17.1

Below pinch-off ($V_D \leq V_{Dsat}$)	Above pinch-off ($V_D > V_{Dsat}$)
$g_d = \frac{Z \bar{\mu}_n C_o}{L} (V_G - V_T - V_D)$ $g_m = \frac{Z \bar{\mu}_n C_o}{L} V_D$	$g_d = 0$ $g_m = \frac{Z \bar{\mu}_n C_o}{L} (V_G - V_T)$



- At the higher operational frequencies encountered in practical applications, the circuit must be modified to take into account capacitive coupling between the device terminals.
- The overlap capacitance is minimized by forming a thicker oxide in the overlap region or preferably through the use of self aligned gate procedures. → C_{gd} is typically negligible.



- **17.3.2. Cutoff Frequency**

The f_T be defined as the frequency where the MOSFET is no longer amplifying the input signal under optimum conditions.

→ Value of the output current to input current ratio is unity

$$i_{in} = j\omega(C_{gs} + C_{gd})v_g \cong j(2\pi f)C_o v_g$$

$$i_{out} \approx g_m v_g$$

$$\left| \frac{i_{out}}{i_{in}} \right| = 1$$

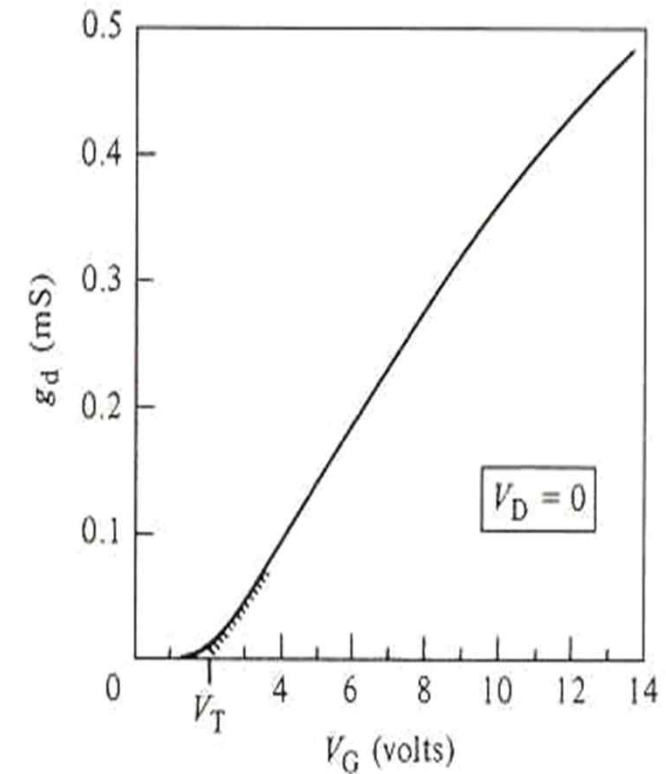
$$\therefore f_T = \frac{g_m}{2\pi C_o} = \frac{\mu_n V_D}{2\pi L^2} \quad \text{if } V_D \leq V_{Dsat}$$



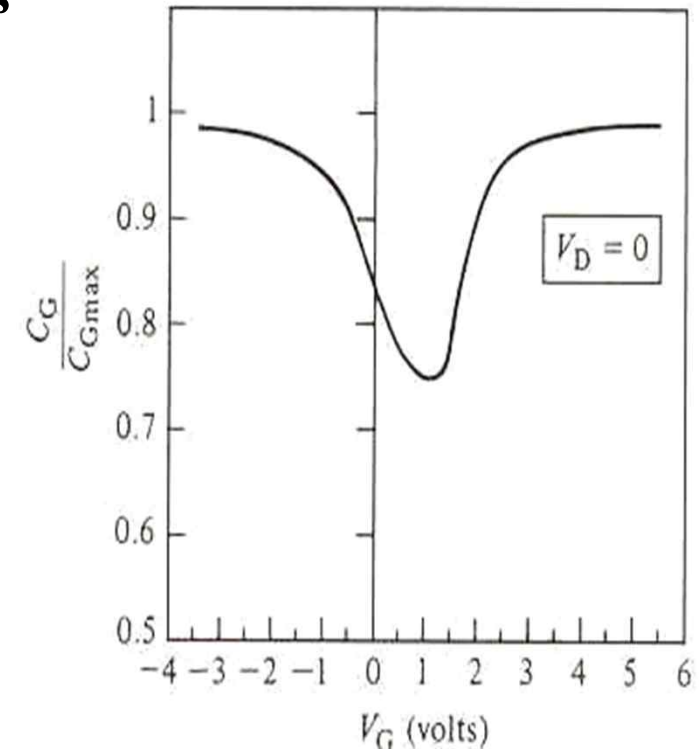
Small Signal Characteristics

- g_d vs. V_G ($V_D = 0$)
 - Extrapolating the linear portion of the g_d - V_G characteristics into the V_G axis and equating the voltage intercept to V_T
 - Deduce the effective mobility from the slope

$$g_d = \frac{W\bar{\mu}_n C_o}{L} (V_G - V_T) \quad (V_D = 0)$$



- Gate Capacitance vs. V_G ($V_D=0$)
 - Diagnostic purposes in much the same manner as the MOS-C $C-V_G$ characteristics
 - Unlike the MOS-C, a low-frequency characteristics is observed even for frequencies exceeding 1MHz
 - Because the source and drain islands supply the minority carries

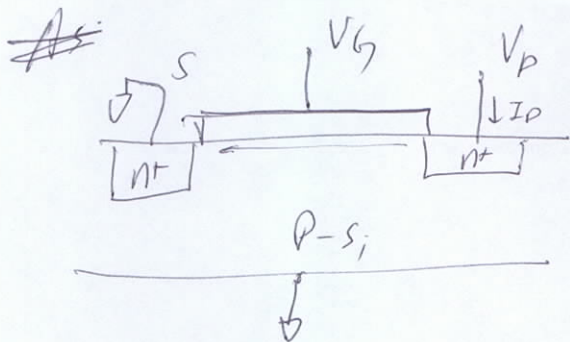


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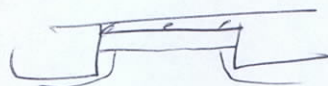
σ_n > σ_p

MOSFET



$V_G < V_T$ ~~no current~~

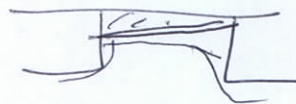
$V_G > V_T$ inversion, conductivity channel (inversion layer)



$V_G \uparrow \rightarrow$ Conductance \uparrow

Simple Resistor ~~up to certain point~~

But as $V_D \uparrow$ $V_D \gg V_G - V_T$ channel $\approx (V_G - \phi) \mu_n \approx$ gate voltage \approx \rightarrow charge $\approx \mu_n \rightarrow$ channel conductance \downarrow (slope over)



Pinch off (of channel) where ~~when~~

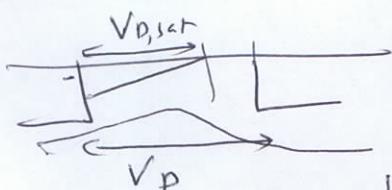
$V_G - V_{D,sat} = V_T$

$V_{D,sat} = V_G - V_T$

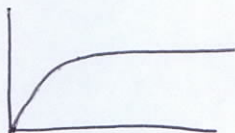


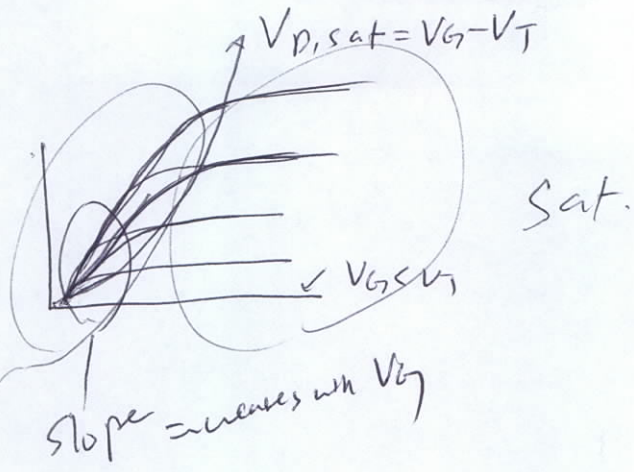
post pinch off $V_D > V_{D,sat}$

The pinched-off region widens & absorbs $V_D - V_{D,sat}$
So the channel sees only $V_{D,sat}$



I_D saturates





linear (triode)

μ_n & Q_{channel} & V_{channel}

Square-Law Theory $\Rightarrow I^{1/2}$

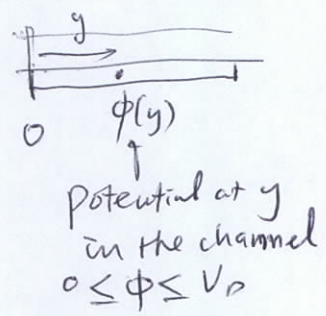
$V_D < V_{D,sat}$

Drift current, $Q_{\text{gate}} = -Q_N$

channel charge at arbitrary point y $Q_N(y) = C_0 (V_G - V_T - \phi(y))$ \leftarrow effective mobility

$$I_D(y) = -W Q_N(y) \cdot \bar{\mu}_n E(y)$$

$$= W \bar{\mu}_n C_0 (V_G - V_T - \phi) \frac{d\phi}{dy}$$



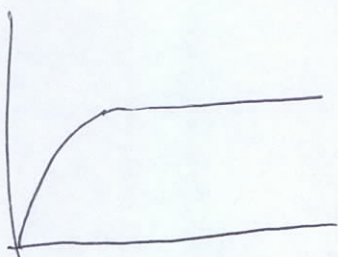
~~I_D~~ $\int_0^L I_D(y) dy = W \bar{\mu}_n C_0 \int_0^{V_D} (V_G - V_T - \phi) d\phi$

$$I_D = \frac{W \bar{\mu}_n C_0}{L} \left[(V_G - V_T) V_D - \frac{V_D^2}{2} \right]$$

$$V_D \geq V_{D,sat}$$

$$I_{D,sat} = I_D \Big|_{V_D,sat = V_G - V_T}$$

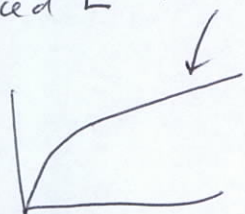
$$= \frac{W \mu_n C_o}{2L} (V_G - V_T)^2$$



When $\Delta L \ll L$, Long channel

$\Delta L \sim L$, Short channel

The reduced L increases current



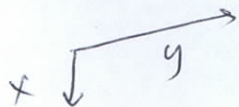
short channel effect!

$\bar{\mu}$

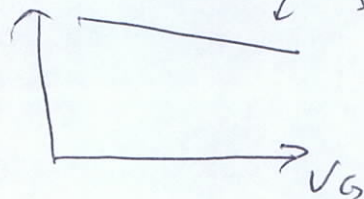
due to surface scattering

in addition to lattice & impurity scattering

$$\bar{\mu} = \frac{\int_0^{x(y)} \mu_n(x,y) n(x,y) dx}{\int_0^{x(y)} n(x,y) dx}$$



$V_G \uparrow$
More carriers at interface
due to surface scattering



Modification

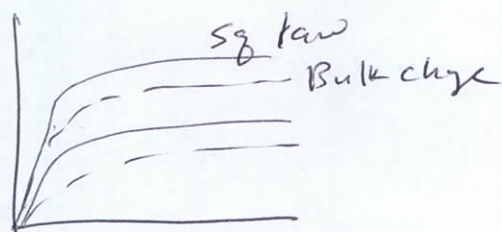
$I_s \propto Q_N = \bar{Q}_N$?
Not exactly.

① Bulk charge theory

Some gate V_G is used to widen the depletion width
 \therefore there is going to be some charge there ~~to~~ to go into the eq

$$Q_{gate} = -(Q_N + Q_W)$$

So actual current will be less



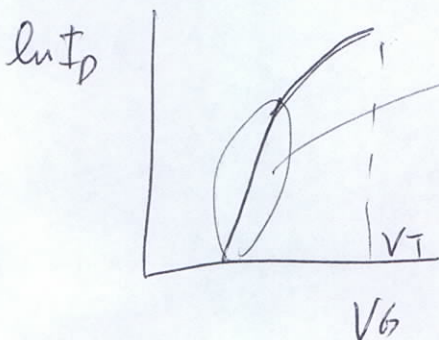
② Subthreshold current

there is still current when $V_G < V_T$ \Rightarrow This is diffusion current
 weak inversion

The charge is $Q_s \propto \exp\left(\frac{qV_G}{kT}\right)$

$$Q_D = Q_s \exp\left(-\frac{qV_{DS}}{kT}\right)$$

$$I_{diff} \propto \frac{Q_s - Q_D}{L} \propto \frac{Q_s}{L} \left[1 - \exp\left(-\frac{qV_D}{kT}\right) \right]$$



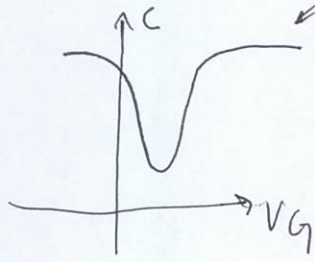
①

slope = $\frac{L}{St} = \frac{d \log I_D}{d V_G}$

$I_{diff} \propto Q_s$
 $I_{diff} \propto \left(\exp \frac{qV_G}{kT} \right)$
 $\therefore I_{diff} \propto V_G$

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MOSFET C-V



MOS-C의
 Lo freq curve is flat MOSFET is not
 high freq is due to Cox and C_{inv}
 inversion cap

∴ source supplies carriers

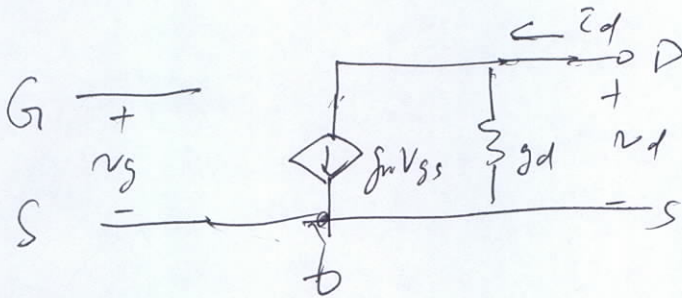
small signal equivalent ckt

$$\bar{I}_D = I_D(V_D, V_G)$$

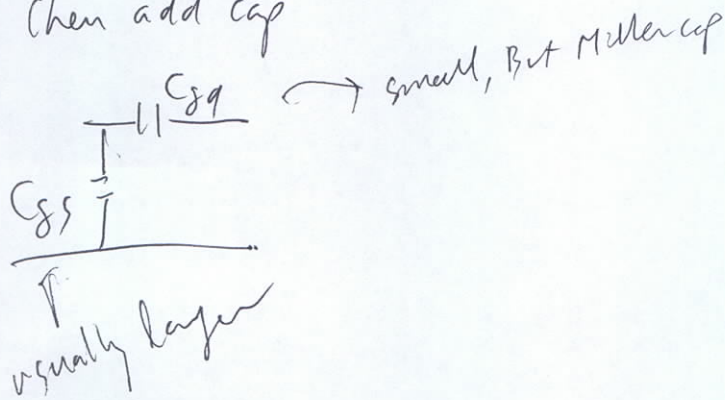
$$\bar{i}_d = \frac{\partial I_D}{\partial V_D} \bigg|_{V_G} v_d + \frac{\partial I_D}{\partial V_G} \bigg|_{V_D} v_g \equiv g_d \cdot v_d + g_m v_g$$

(V_D, V_G) Bias point

g_d (channel conductance)
 g_m (transconductance)



Then add cap



Linear Triode Regn

$$I_D = \frac{\mu_n C_{ox}}{L} \left[(V_G - V_T) V_D - \frac{V_D^2}{2} \right]$$

$$g_d = \frac{\partial I_D}{\partial V_D} \bigg|_{V_G} = \frac{\mu_n C_{ox}}{L} [V_G - V_T - V_D]$$

$$g_m = \frac{\partial I_D}{\partial V_G} \bigg|_{V_D} = \frac{\mu_n C_{ox}}{L} [V_D]$$



Sat. Regn

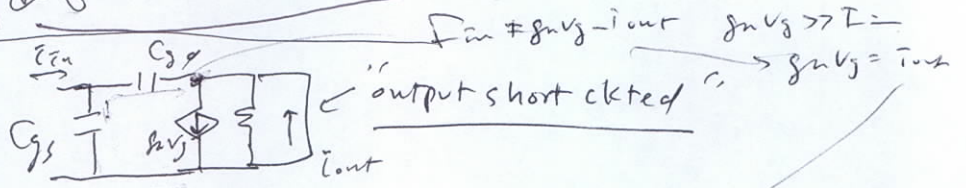
$$I_D = \frac{\mu_n C_{ox}}{2L} (V_G - V_T)^2$$

$$g_d = 0$$

$$g_m = \frac{\mu_n C_{ox}}{L} (V_G - V_T)$$

defined as max-freq where $\left| \frac{i_{out}}{i_{in}} \right| = 1$ with output short circuited.

Cutoff freq



$$\bar{i}_{in} = j\omega (C_{gs} + C_{gd}) v_g \approx j(2\pi f) C_{ox} v_g$$

$$\bar{i}_{out} \approx g_m v_g \approx C_{ox} \text{ (small)}$$

$$\left| \frac{\bar{i}_{out}}{\bar{i}_{in}} \right| = 1 \text{ at } 1/2 \text{ freq?}$$

$$\text{at } f_T = \frac{g_m}{2\pi C_{ox}} \text{ if } V_D \ll V_{DSAT}$$

$$\frac{g_m v_g}{2\pi f C_{ox} v_g} = 1 \rightarrow f = \frac{g_m}{2\pi C_{ox}} \leftarrow \text{transconductance}$$

$$\frac{g_m}{\mu_n} \approx \frac{2L}{2\pi} !$$